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NDS9959

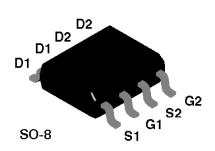
Dual N-Channel Enhancement Mode Field Effect Transistor

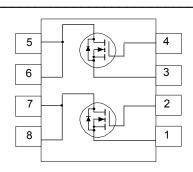
General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as DC motor control and DC/DC conversion where fast switching, low in-line power loss, and resistance to transients are needed.

Features

- 2.0A, 50V. $R_{DS(ON)} = 0.3\Omega$ @ $V_{GS} = 10V$
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.
- Dual MOSFET in surface mount package.





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		NDS9959	Units
V _{DSS}	Drain-Source Voltage		50	V
V_{GSS}	Gate-Source Voltage		± 20	V
D	Drain Current - Continuous @ T _A = 25°C	(Note 1a)	± 2.0	A
	- Continuous @ T _A = 70°C	(Note 1a)	± 1.6	
	- Pulsed @ T _A = 25°C		±8	
P_{D}	Power Dissipation for Dual Operation		2	W
	Power Dissipation for Single Operation	(Note 1a)	1.6	
		(Note 1b)	1	
		(Note 1c)	0.9	
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to 150	°C
THERMA	L CHARACTERISTICS			
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
R _{⊕IC}	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{gs} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		50			V
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$				2	μA
			T _J = 55°C			25	μA
GSSF	Gate - Body Leakage, Forward	V _{GS} = 20 V, V _{DS} = 0 V				100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
ON CHAR	ACTERISTICS (Note2)					•	•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		2	3	4	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 1.5 A				0.3	Ω
		$V_{GS} = 5 \text{ V}, I_{D} = 0.6 \text{ A}$				0.5	
D(on)	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 5 V		8			Α
9 _{FS}	Forward Transconductance	V _{DS} = 15 V, I _D = 2.0 A		1	2.7		S
DYNAMIC	CHARACTERISTICS	·					
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz}$			152	250	pF
C _{oss}	Output Capacitance				50	85	pF
C_{rss}	Reverse Transfer Capacitance				12	25	pF
SWITCHIN	NG CHARACTERISTICS (Note 2)						
D(on)	Tum - On Delay Time	$V_{DD} = 30 \text{ V}, I_{D} = 0.6 \text{ A},$			4	40	ns
Ļ	Turn - On Rise Time	$V_{GS} = 10 \text{ V}, R_{L} = 50 \Omega,$			8	70	ns
D(off)	Turn - Off Delay Time	$R_{GEN} = 6 \Omega$			9	100	ns
ţ	Turn - Off Fall Time				11	70	ns
Q_g	Total Gate Charge	$V_{DS} = 25 \text{ V},$ $I_{D} = 1.3 \text{ A}, V_{GS} = 10 \text{ V}$			4.3	15	nC
Q_{gs}	Gate-Source Charge	$I_D = 1.3 \text{ A}, \ V_{GS} = 10 \text{ V}$			1.1		nC
Q_{gd}	Gate-Drain Charge				1.5		nC

Electrical Characteristics (T _A = 25°C unless otherwise noted)							
Symbol	Parameter Conditions		Min	Тур	Max	Units	
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS							
I _s	Maximum Continuos Drain-Source Diode Forward Current				1.8	Α	
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 1.25 A (Note 2)		0.84	1.2	V	
t,	Reverse Recovery Time	$V_{GS} = 0V$, $I_F = 1.25$ A, $dI_F/dt = 100$ A/ μ s			100	ns	

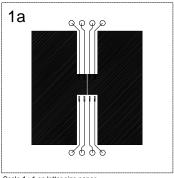
Notes:

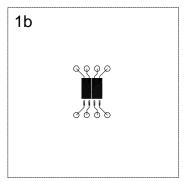
1. R_{Bux} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{Buc} is guaranteed by design while R_{Bux} is determined by the user's board design.

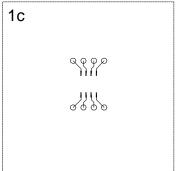
$$P_D(t) = \frac{T_{J} - T_A}{R_{\theta J} A^{(t)}} = \frac{T_{J} - T_A}{R_{\theta J} d R_{\theta C} A^{(t)}} = I_D^2(t) \times R_{DS(ON) \Theta T_J}$$

Typical R_{BJA} for single device operation using the board layouts shown below on 4.5"x5" FR-4 PCB in a still air environment:

- a. 78°C/W when mounted on a 0.5 in² pad of 2oz cpper.
- b. 125°C/W when mounted on a 0.02 in² pad of 2oz cpper.
- c. 135°C/W when mounted on a 0.003 in² pad of 2oz cpper.







Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width $\leq 300 \mu s,$ Duty Cycle $\leq 2.0 \%.$

Typical Electrical Characteristics

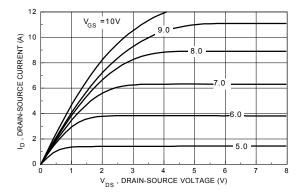


Figure 1. On-Region Characteristics.

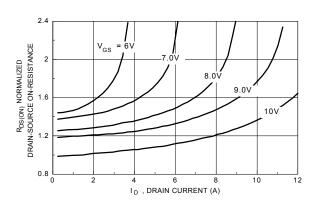


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current.

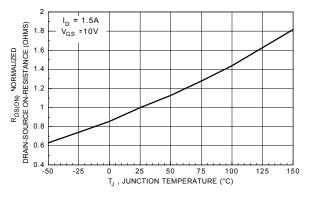


Figure 3. On-Resistance Variation with Temperature.

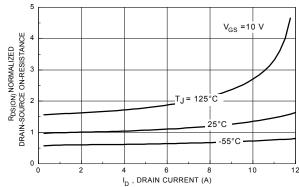


Figure 4. On-Resistance Variation with Drain Current and Temperature.

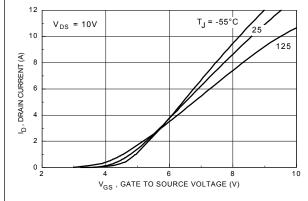


Figure 5. Transfer Characteristics.

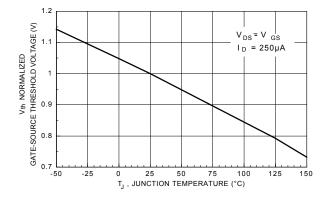


Figure 6. Gate Threshold Variation with Temperature.

Typical Electrical Characteristics (continued)

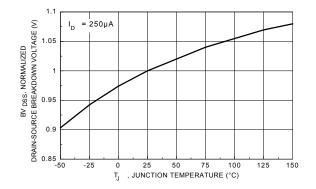


Figure 7. Breakdown Voltage Variation with Temperature.

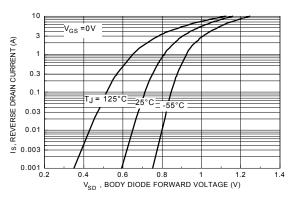


Figure 8. Body Diode Forward Voltage
Variation with Current and Temperature

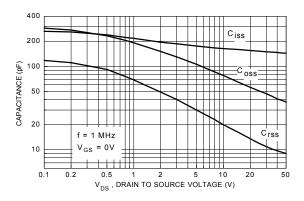


Figure 9. Capacitance Characteristics.

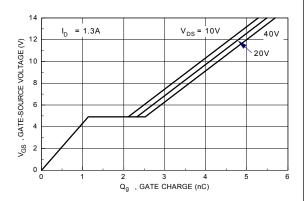


Figure 10. Gate Charge Characteristics.

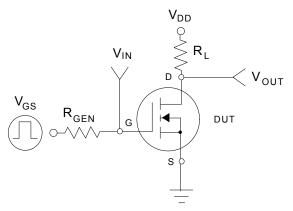


Figure 11. Switching Test Circuit

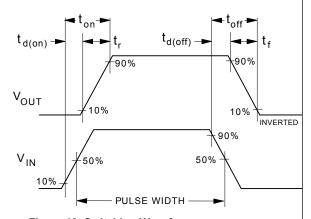
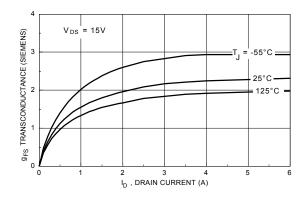


Figure 12. Switching Waveforms

Typical Electrical Characteristics (continued)



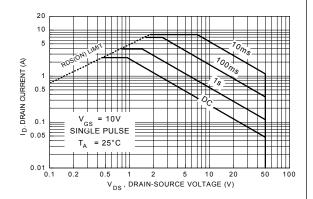


Figure 13. Transconductance Variation with Drain Current.

Figure 14. Maximum Safe Operating Area.

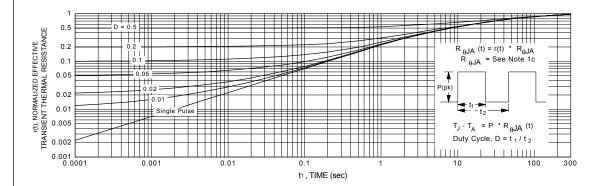


Figure 15. Transient Thermal Response Curve.

Note: Thermal characterization performed using the conditions described in note 1c. Transient thermal response will change depending on the circuit board design.

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